ABSOCIATION CONNECTING LECTRONICS INDUSTRIES® Material Compositio © Copyright 2005. IPC, Ba international and Pan-Ame	nnockburn, Illinois, A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declaratio he declaration en	n of the sub compasses	ostances w all lower l	vithin the manufactur level materials for wh	er listed iter hich the ma	n. Note: i nufacturer	f the item is an as has engineering	sembly with lower responsibility.
52.21.1 IPC Web Site for Information on IPC-1752 Standard Form Typ			Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on			
Supplier Information												
Company name* Company unique ID			Unique ID			e ID Authority			Response Date*			
onsemi	isemi								2024-04-30			
Contact Name	Title - Contact]	Phone - Contact*				Email - Contact*			
Product-Env-Stewards	duct-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative				1	Phone - Representative*				Email - Representative*			
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Item Number N	Ifr Item Number	Mfr Item Name			Effective Date	Version	Ma	Manufacturing Site		eight*	UOM	Unit Type
	CP59744FCTCADJT G	744FCTCADJT NCP59744 in WLCSP10			2024-04-30		CN	CNQ		57	mg	Each
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	Terminal Base	Terminal Base Alloy J-STD-020 MS			Peak Process Body Temperature Max Time at Peak			Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy 1		1		260		С	30	seconds	3			
Comments												
evel 1 - maximum time at peak temperature du	ring soldering is 10-3	0 seconds										
For more information regarding material comp	osition please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or [F] Optionally enter the positive (-				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.072	mg	Supplier	Silicon (Si)	7440-21-3		1.072	mg
Protection coat	0.1205	mg		Polyimide	proprietary data		0.1205	mg
RDL	0.056	mg	Supplier	Copper (Cu)	7440-50-8		0.056	mg
RDL Sputter	0.0028	mg	Supplier	Titanium (Ti)	7440-32-6		0.0006	mg
			Supplier	Copper (Cu)	7440-50-8		0.0022	mg
Solder preform	0.279	mg	Supplier	Tin (Sn)	7440-31-5		0.279	mg
UBM Sputter	0.0017	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.0015	mg
Under Bump Metal	0.038	mg	Supplier	Copper (Cu)	7440-50-8		0.038	mg